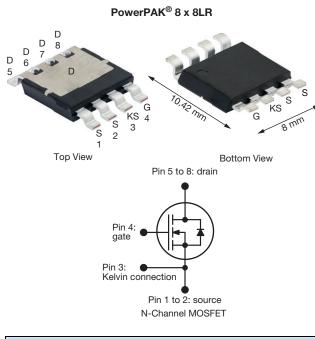
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Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.094		
Q _g max. (nC)	53			
Q _{gs} (nC)	16			
Q _{gd} (nC)	8			
Configuration	Single			

FEATURES

- 4th generation E series technology
- Low figure of merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8LR
Lead (Pb)-free and halogen-free	SiHR100N60EF-T1GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)							
PARAMETER		SYMBOL	LIMIT	UNIT			
Drain-source voltage		V _{DS}	600	v			
Gate-source voltage			V _{GS}	± 30	v		
Continuous drain current ($T_J = 150 \ ^{\circ}C$)	V _{GS} at 10 V	T _C = 25 °C	Ι _D	38			
	VGS AL TO V	T _C = 100 °C		24	А		
Pulsed drain current ^a			I _{DM}	64			
Linear derating factor			2.8	W/°C			
Single pulse avalanche energy ^b			E _{AS}	173	mJ		
Maximum power dissipation		P _D	P _D 347				
Operating junction and storage temperature ra	ange		T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope		T _J = 125 °C	dv/dt	100	V/ns		
Reverse diode dv/dt ^d			uv/dl	14	V/ns		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. $V_{DD} = 120 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 28.2 mH, $R_g = 25 \Omega$, $I_{AS} = 3.5 \text{ A}$

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

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COMPLIANT

HALOGEN

FREE



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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		42				
Maximum junction-to-case (drain)	R _{thJC}	- 0.36			°C/W			
		·						
SPECIFICATIONS (T _J = 25 °C,	unless otherw	ise noted)						
PARAMETER	SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static	•							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I _D = 1 mA		-	0.53	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	3.0	-	5.0	V
Cata aquiraa laakaga		,	V _{GS} = ± 20 V		-	-	± 100	nA
Gate-source leakage	IGSS	$V_{GS} = \pm 30 V$		V	-	-	± 1	μA
Zero gate voltage drain current		V _{DS} =	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	μA
	IDSS	V _{DS} = 480 V	′, V _{GS} = 0 V	, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	۱ _с	₀ = 13 A	-	0.094	0.108	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} = 8 V, I _D = 13 A		-	12	-	S	
Dynamic		<u>.</u>						
nput capacitance	C _{iss}		$V_{GS} = 0 V_{S}$		-	2198	-	
Output capacitance	C _{oss}	$V_{DS} = 100 V,$ f = 100 kHz $V_{DS} = 0 \text{ V to 400 V}, V_{GS} = 0 \text{ V}$		-	82	-	pF	
Reverse transfer capacitance	C _{rss}			-	2	-		
Effective output capacitance, energy related ^a	C _{o(er)}			-	89	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	548	-		
Total gate charge	Qg		V _{GS} = 10 V I _D = 13 A, V _{DS} = 480 V		-	35	53	nC
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$			-	16	-	
Gate-drain charge	Q _{gd}				-	8	-	
Turn-on delay time	t _{d(on)}				-	25	50	
Rise time	t _r	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 480 \text{ V}, \text{ I}_{\text{D}} = 13 \text{ A}, \\ V_{\text{GS}} = 10 \text{ V}, \text{ R}_{\text{g}} = 9.1 \ \Omega \end{array}$		-	45	90	ns	
Turn-off delay time	t _{d(off)}			-	37	74		
Fall time	t _f			-	30	60		
Gate input resistance	Rg	f = 1 MHz		0.3	0.6	1.2	Ω	
Drain-Source Body Diode Characteris								
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	38		
Pulsed diode forward current	I _{SM}			-	-	64	A	
Diode forward voltage	V _{SD}	$T_{\rm J}$ = 25 °C, $I_{\rm S}$ = 13 A, $V_{\rm GS}$ = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 13 \text{ A},$ di/dt = 100 A/µs, V _R = 400 V		-	138	276	ns	
Reverse recovery charge	Q _{rr}			-	0.7	1.4	μC	
Reverse recovery current	I _{RRM}			-	8	-	A	



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

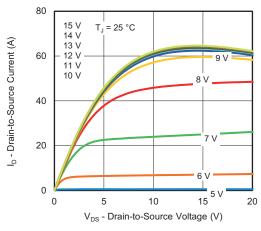


Fig. 1 - Typical Output Characteristics

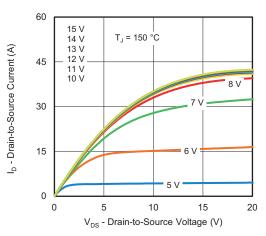


Fig. 2 - Typical Output Characteristics

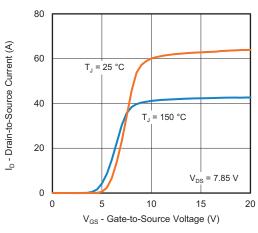


Fig. 3 - Typical Transfer Characteristics

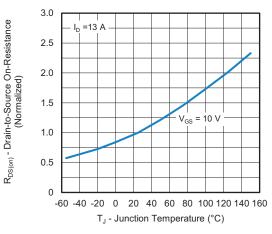


Fig. 4 - Normalized On-Resistance vs. Temperature

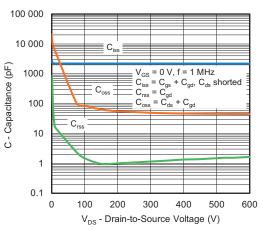
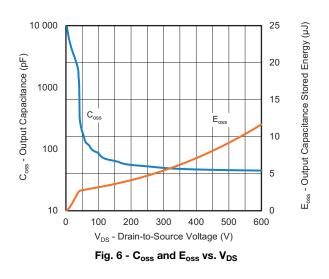


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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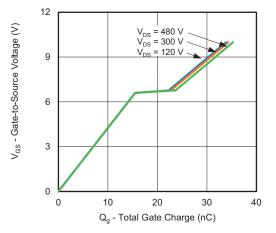


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

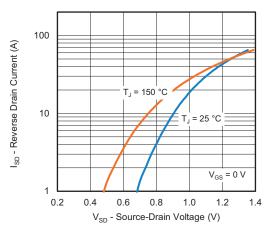
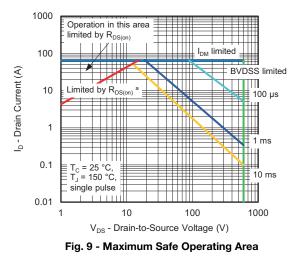


Fig. 8 - Typical Source-Drain Diode Forward Voltage



Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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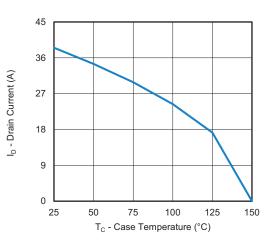


Fig. 10 - Maximum Drain Current vs. Case Temperature

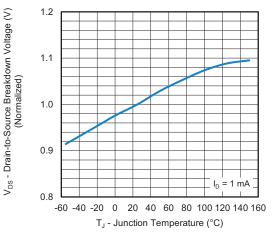


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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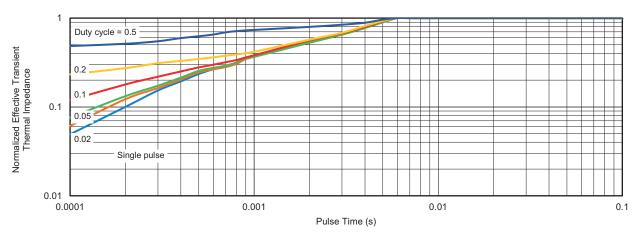


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

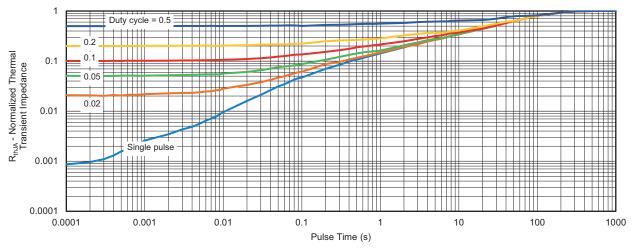


Fig. 13 - Normalized Transient Thermal Impedance, Junction-to-Ambient

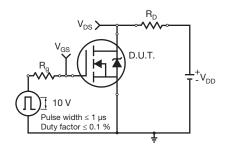


Fig. 14 - Switching Time Test Circuit

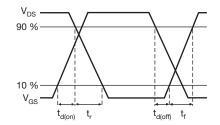


Fig. 15 - Switching Time Waveforms



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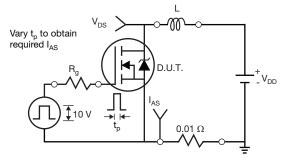


Fig. 16 - Unclamped Inductive Test Circuit

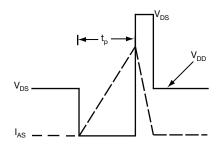


Fig. 17 - Unclamped Inductive Waveforms

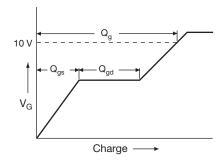


Fig. 18 - Basic Gate Charge Waveform

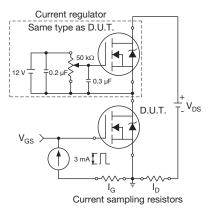


Fig. 19 - Gate Charge Test Circuit



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Peak Diode Recovery dv/dt Test Circuit

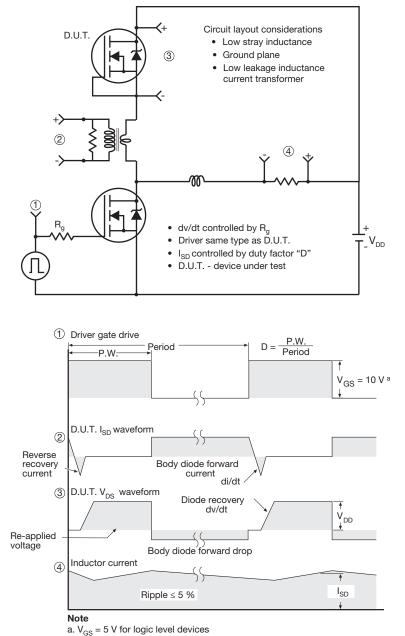


Fig. 20 - For N-Channel

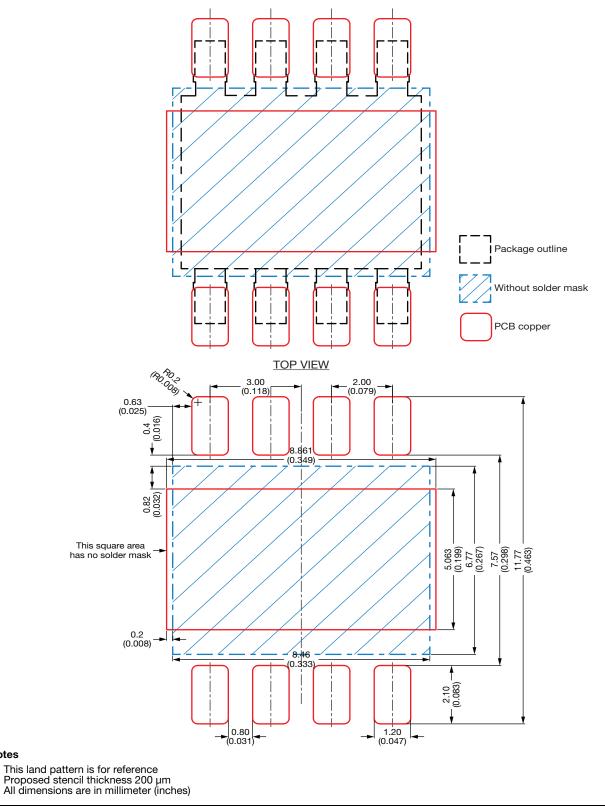
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PAD Pattern



Vishay Siliconix

Recommended Land Pattern PowerPAK® 8 x 8LR



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Revision: 11-Dec-2023

Notes

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